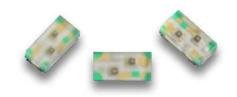


APHB1608CGKSEKC

1.6 x 0.8 x 0.5 mm Bi-Color Surface Mount LED



DESCRIPTIONS

- The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Super Bright Orange device is made with AlGaInP (on GaAs substrate) light emitting diode chip
- Electrostatic discharge and power surge could damage the LEDs
- . It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

FEATURES

- 1.6 x 0.8 mm SMD LED, 0.5 mm thickness
- · Compatible with reflow soldering
- · Available in various color combination
- · Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Tinned pads for improved solderability
- Halogen-free
- · RoHS compliant

APPLICATIONS

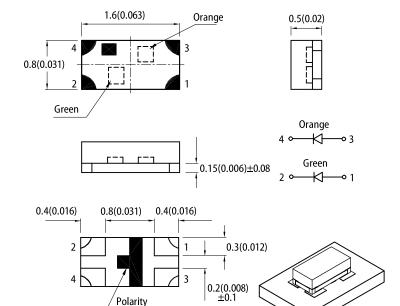
- Backlight
- · Status indicator
- · Home and smart appliances
- Wearable and portable devices
- · Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices



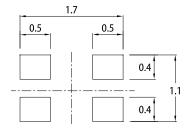
PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

Mark

(units: mm; tolerance: ± 0.1)



- 17. All dimensions are in millimeters (inches).
 2. Tolerance is ±0.15(0.006") unless otherwise noted.
 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
- The device has a single mounting surface. The device must be mounted according to the specifications **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 20mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
APHB1608CGKSEKC	Green (AlGalnP)	Water Clear	20	50	130°
			*20	*50	
	Super Bright Orange (AlGaInP)		120	250	
			*80	*200	

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

* Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		11-4
Parameter			Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 20mA	λ_{peak}	Green Super Bright Orange	574 610	-	nm
Dominant Wavelength I _F = 20mA	λ _{dom} ^[1]	Green Super Bright Orange	570 605	-	nm
Spectral Bandwidth at 50% Φ REL MAX I _F = 20mA	Δλ	Green Super Bright Orange	20 29	-	nm
Capacitance	С	Green Super Bright Orange	15 15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	Green Super Bright Orange	2.1 2.1	2.5 2.5	V
Reverse Current (V _R = 5V)	I _R	Green Super Bright Orange	-	10 10	μА
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C \leq T \leq 85°C	TC_{\lambdapeak}	Green Super Bright Orange	0.12 0.13	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C $\leq T \leq 85^{\circ}C$	TC _{λdom}	Green Super Bright Orange	0.08 0.06	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TC _v	Green Super Bright Orange	-1.9 -1.9	-	mV/°C

Notes:

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

Parameter	Symbol	Va	llmit		
Farameter	Symbol	Green	Super Bright Orange	Unit	
Power Dissipation	P_{D}	75	75	mW	
Reverse Voltage	V_R	5	5	V	
Junction Temperature	Tj	115	115	°C	
Operating Temperature	T _{op}	-40 to +85		°C	
Storage Temperature	T _{stg}	-40 to +85		°C	
DC Forward Current	I _F	30	30	mA	
Peak Forward Current	I _{FM} ^[1]	150	195	mA	
Electrostatic Discharge Threshold (HBM)	-	3000	3000	V	
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	480	700	°C/W	
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	350	540	°C/W	

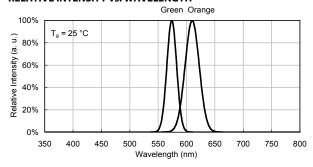
Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. R_{Ib. JA}, R_{Ib. US} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



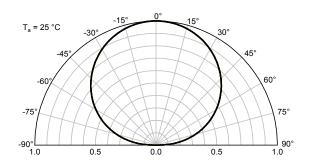


TECHNICAL DATA

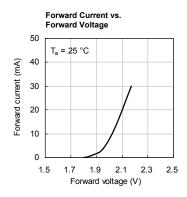
RELATIVE INTENSITY vs. WAVELENGTH

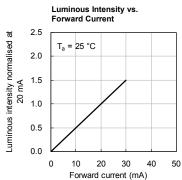


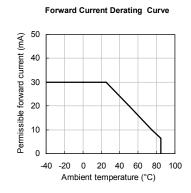
SPATIAL DISTRIBUTION

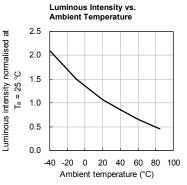


GREEN

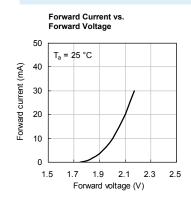


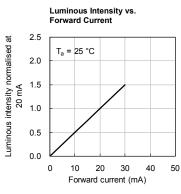


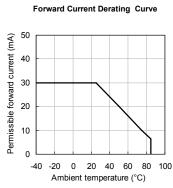


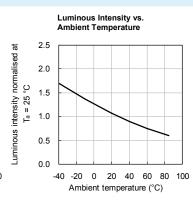


SUPER BRIGHT ORANGE











REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

300 above 255°C 260°C max. 30s max. 250 10s max. 3°C/s max 6°C/s max. 200 150 Temperature pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 .25°C 0 50 100 150 200 250 300 Time

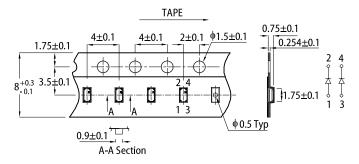
- Notes:

 1. Don't cause stress to the LEDs while it is exposed to high temperature.

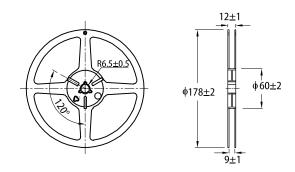
 2. The maximum number of reflow soldering passes is 2 times.

 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

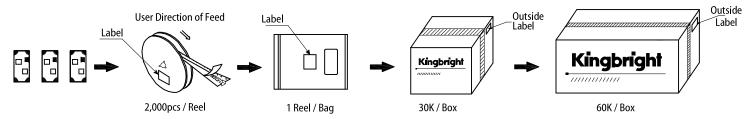
TAPE SPECIFICATIONS (units:mm)



REEL DIMENSION (units: mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
- the latest datasheet for the updated specifications.

 When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- toustomer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
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